

# FFPF20UP30S Ultrafast Recovery Power Rectifier

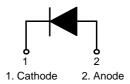
#### **Features**

- Ultrafast Switching Speed : ‡ < 35ns (@I<sub>F</sub>=20A)
- High Reverse Voltage :  $\bigvee_{RM}$  = 300V
- Avalanche Energy Rated
- Planar Construction

## **Applications**

- General purpose
- · Switching Mode Power Supply
- Free-wheeling diode for motor application
- Power switching circuits





### Absolute Maximum Ratings (per diode) T<sub>a</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	300	V
$V_{RWM}$	Working Peak Reverse Voltage	300	V
V <sub>R</sub>	DC Blocking Voltage	300	V
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 85°C	20	A
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	200	А
T <sub>J</sub> , T <sub>STG</sub>	Operating Junction and Storage Temperature	- 65 to +150	°C

## Thermal Characteristics $T_a = 25\%$ unless otherwise noted

Symbol	Parameter	Max	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	3.7	°C/W

## **Package Marking and Ordering Information**

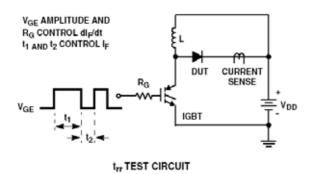
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
F20UP30S	FFPF20UP30STU	TO-220F	-	-	50

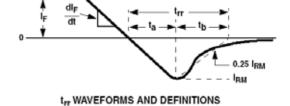
## **Electrical Characteristics** (per diode) $T_a = 25\%$ unless otherwise noted

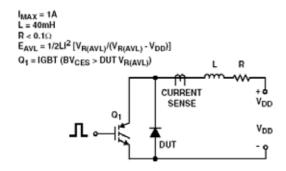
Symbol	Parameter		Min.	Тур.	Max.	Units
V <sub>FM</sub> *	I <sub>F</sub> = 20A I <sub>F</sub> = 20A	T <sub>C</sub> = 25 °C T <sub>C</sub> = 150 °C	-	-	1.5 1.3	V V
I <sub>RM</sub> *	V <sub>R</sub> = 300V V <sub>R</sub> = 300V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 150 °C	-	-	100 500	μΑ μΑ
t <sub>rr</sub>	$\begin{split} I_F = &1A, \ di/dt = 100A/\mu s, \ V_{CC} = 30V \\ I_F = &20A, \ di/dt = 200A/\mu s, \ V_{CC} = 195V \\ I_F = &20A, \ di/dt = 200A/\mu s, \ V_{CC} = 195V \end{split}$	$T_{C} = 25  ^{\circ}\text{C}$ $T_{C} = 25  ^{\circ}\text{C}$ $T_{C} = 125  ^{\circ}\text{C}$	- - -	- - -	30 35 60	ns ns ns
t <sub>a</sub> t <sub>b</sub> Q <sub>rr</sub>	$I_F = 20A$ , di/dt = 200A/ $\mu$ s, $V_{CC} = 195V$	$T_C = 25 ^{\circ}C$ $T_C = 25 ^{\circ}C$ $T_C = 25 ^{\circ}C$	- - -	13 12 25	- - -	ns ns nC
W <sub>AVL</sub>	Avalanche Energy (L = 40mH)		20	-	-	mJ

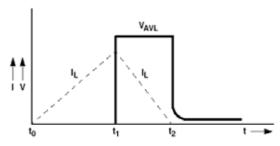
<sup>\*</sup> Pulse Test: Pulse Width=300µs, Duty Cycle=2%

#### **Test Circuit and Waveforms**







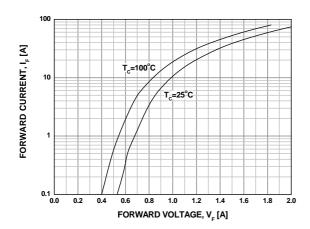


AVALANCHE ENERGY TEST CIRCUIT

AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

## **Typical Performance Characteristics**

Figure 1. Typical Forward Voltage Drop



**Figure 2. Typical Reverse Current** 

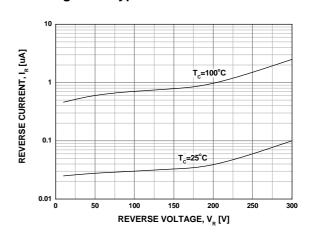


Figure 3. Typical Junction Capacitance

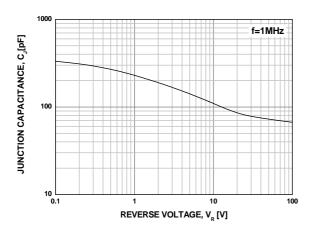


Figure 4. Typical Reverse Recovery Time

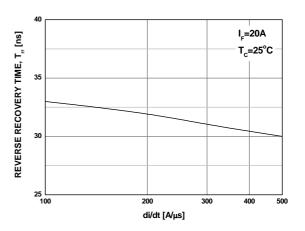
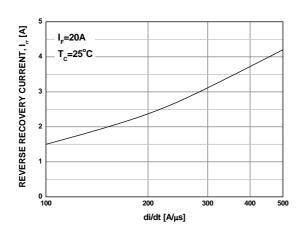
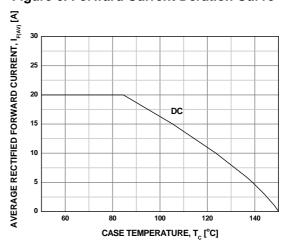


Figure 5. Typical Reverse Recovery Current

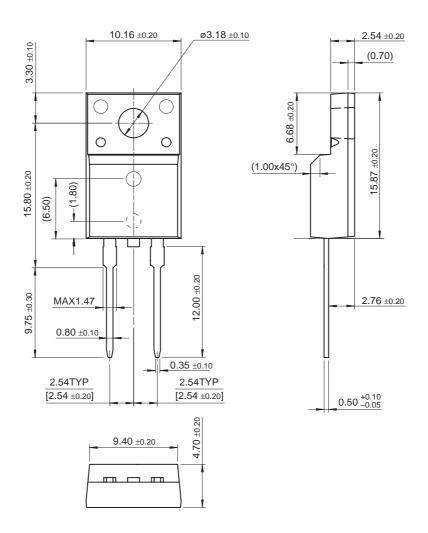


**Figure 6. Forward Current Deration Curve** 



# **Package Demensions**

# TO-220F 2L



Dimensions in Millimeters

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IntelliMAX™	OPTOLOGIC <sup>®</sup>	SILENT SWITCHER®	Wire™
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ia the world.	POP™	Stealth™	
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